

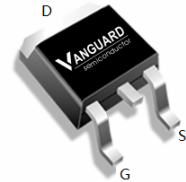
Features

- N-Channel, 10V Logic level control
- Enhancement mode
- Fast Switching
- Very low on-resistance $R_{DS(on)}$
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

V_{DS}	150	V
$R_{DS(on),TYP}@ V_{GS}=10\text{ V}$	30	m Ω
I_D	40	A



TO-252



Part ID	Package Type	Marking	Tape and reel information
VSD050N15HS	TO-252	050N15H	2500pcs/Reel

Maximum ratings, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_c=25\text{ }^\circ\text{C}$ Unless Otherwise Noted)				
V_{GS}	Gate-Source Voltage	± 20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	150	V	
T_j	Maximum Junction Temperature	175	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$	
I_s	Diode Continuous Forward Current	$T_c=25\text{ }^\circ\text{C}$	40	
Mounted on Large Heat Sink				
I_D	Continuous Drain current@ $V_{GS}=10\text{V}$	$T_c=25\text{ }^\circ\text{C}$	40	A
		$T_c=100\text{ }^\circ\text{C}$	24	A
I_{DM}	Pulse Drain Current Tested ①	$T_c=25\text{ }^\circ\text{C}$	100	A
P_D	Maximum Power Dissipation	$T_c=25\text{ }^\circ\text{C}$	100	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		1.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		52.5	$^\circ\text{C/W}$
Drain-Source Avalanche Ratings				
EAS	Avalanche Energy, Single Pulsed ②		60	mJ

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	150	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _c =25°C)	V _{DS} =150V, V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T _c =125°C)	V _{DS} =150V, V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2.0	3.0	4.0	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =10V, I _D =25A	--	30	50	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =6V, I _D =10A	--	32	50	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	--	4570	--	pF
C _{oss}	Output Capacitance		--	195	--	pF
C _{rss}	Reverse Transfer Capacitance		--	130	--	pF
Q _g	Total Gate Charge	V _{DS} =75V, I _D =10A, V _{GS} =10V	--	46	--	nC
Q _{gs}	Gate-Source Charge		--	15	--	nC
Q _{gd}	Gate-Drain Charge		--	13	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =75V, I _D =10A, R _G =6.8Ω, V _{GS} =10V	--	22	--	nS
t _r	Turn-on Rise Time		--	11	--	nS
t _{d(off)}	Turn-Off Delay Time		--	38	--	nS
t _f	Turn-Off Fall Time		--	14	--	nS
Source- Drain Diode Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	I _{SD} =25A, V _{GS} =0V	--	0.86	1.2	V
t _{rr}	Reverse Recovery Time	T _j =25°C, I _{sd} =10A, V _{GS} =0V	--	50	--	nS
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs		385		nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{jmax}, starting T_J = 25°C, L = 0.3mH, R_G = 25Ω, I_{AS} = 20A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

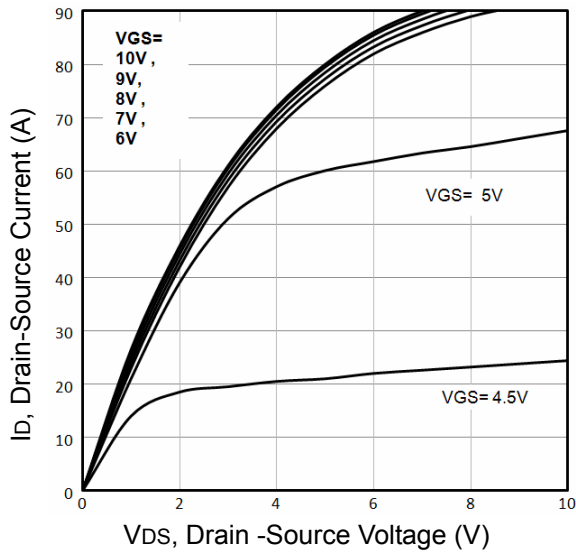


Fig1. Typical Output Characteristics

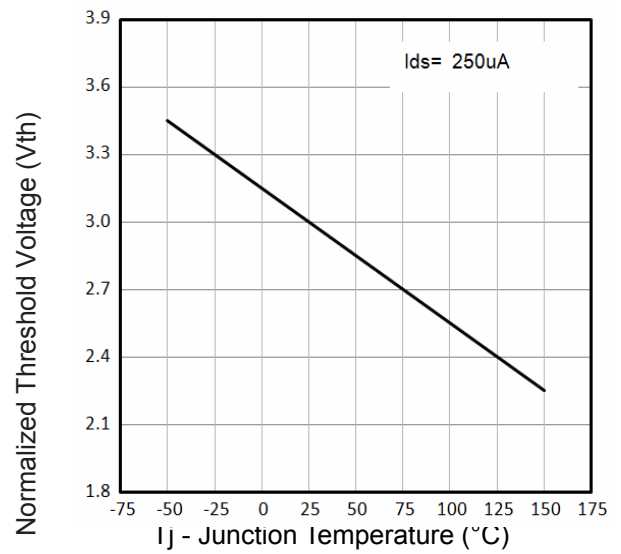


Fig2. Normalized Threshold Voltage Vs. Temperature

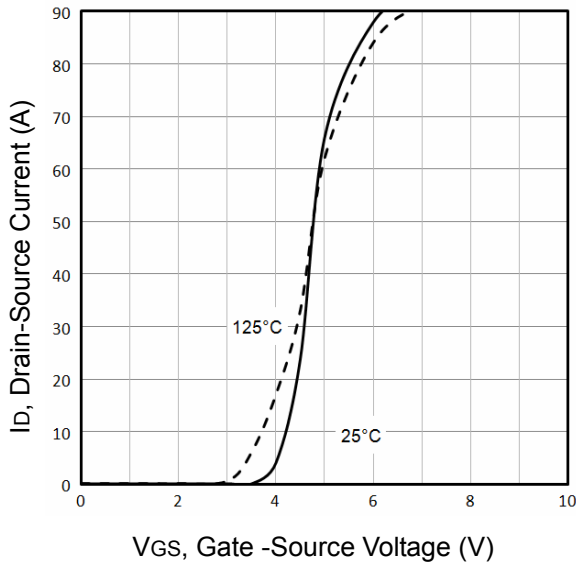


Fig3. Typical Transfer Characteristics

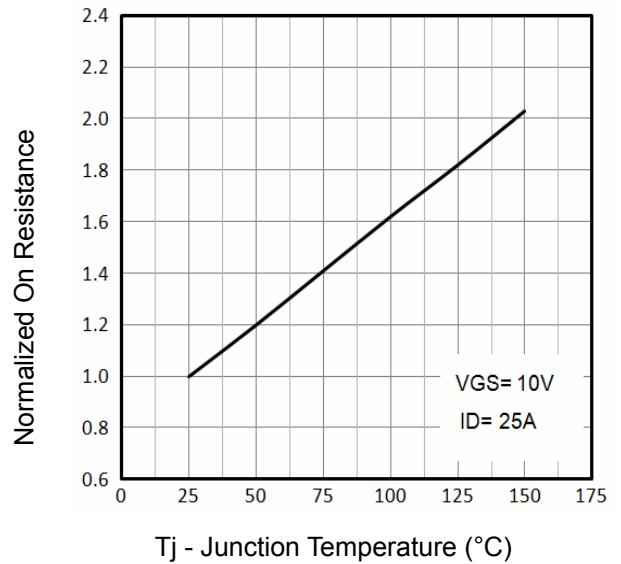


Fig4. Normalized On-Resistance Vs. Temperature

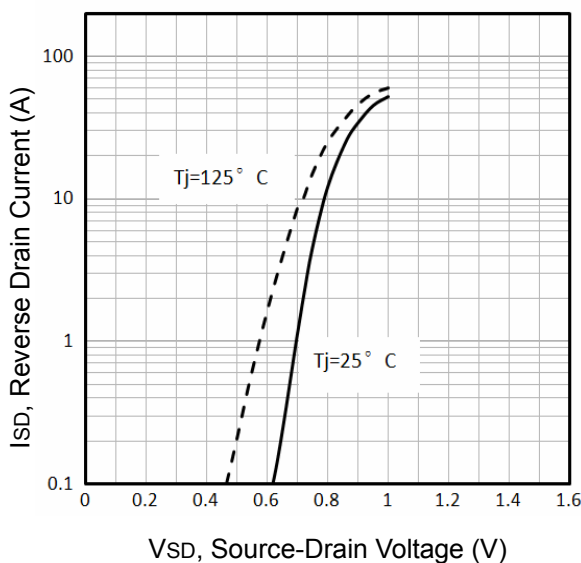


Fig5. Typical Source-Drain Diode Forward Voltage

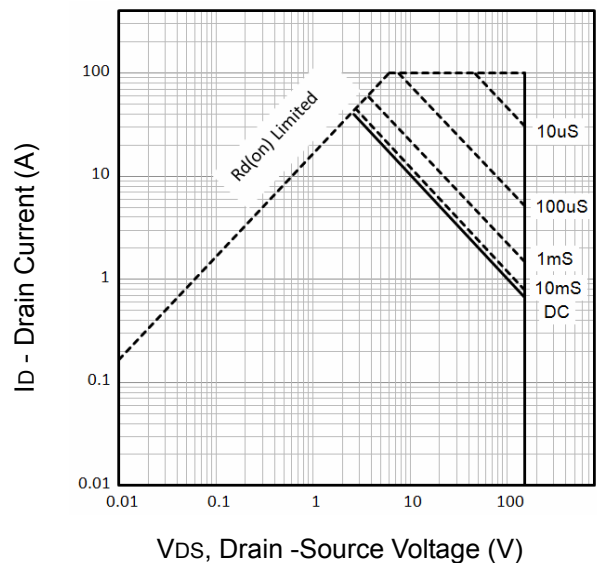


Fig6. Maximum Safe Operating Area

Typical Characteristics

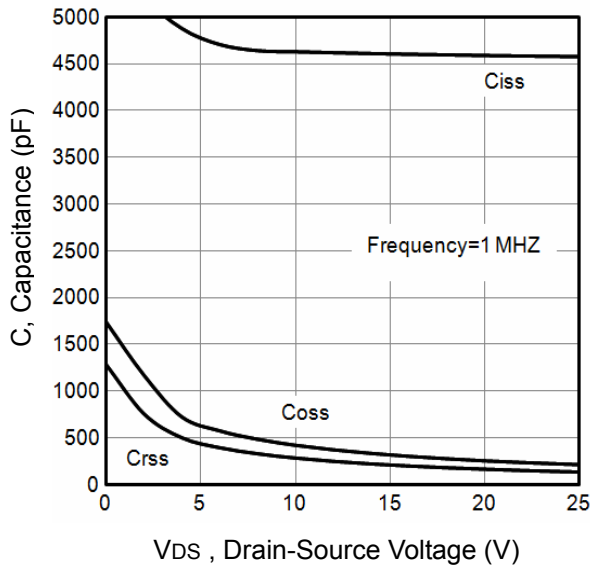


Fig7. Typical Capacitance Vs.Drain-Source

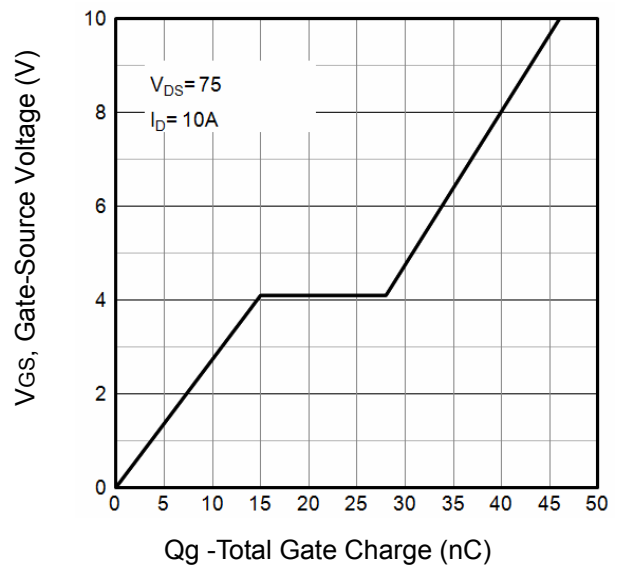


Fig8. Typical Gate Charge Vs.Gate-Source

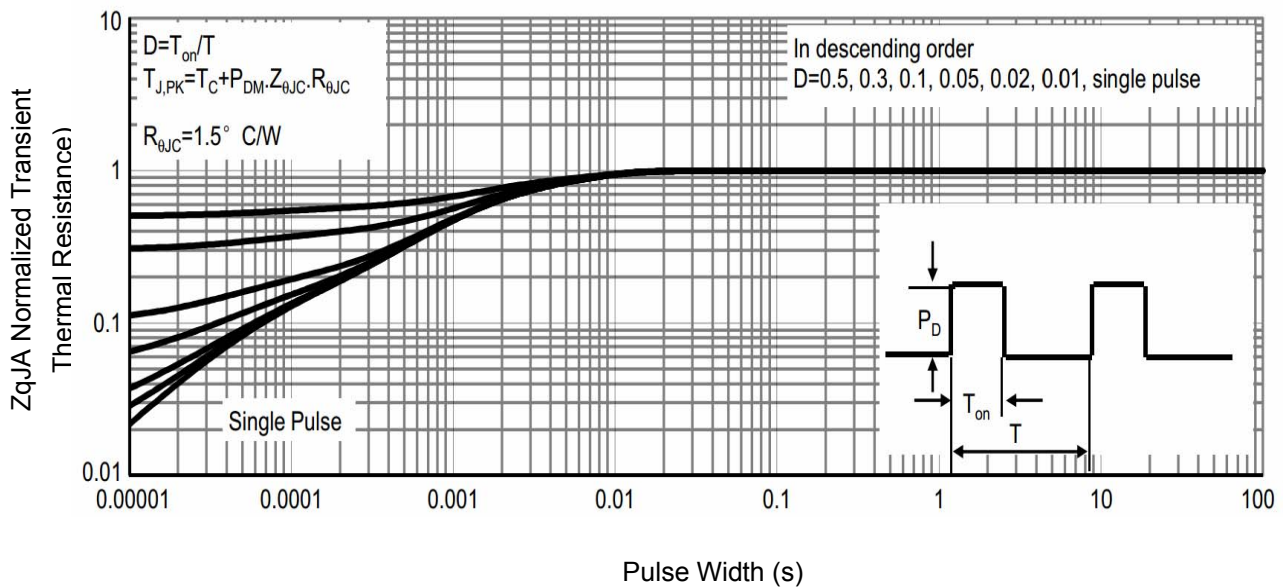


Fig9. Normalized Maximum Transient Thermal Impedance

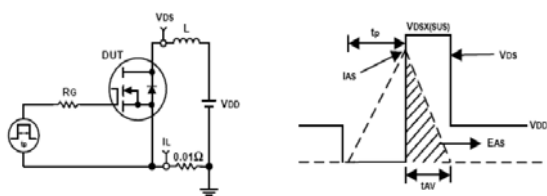


Fig10. Unclamped Inductive Test Circuit and waveforms

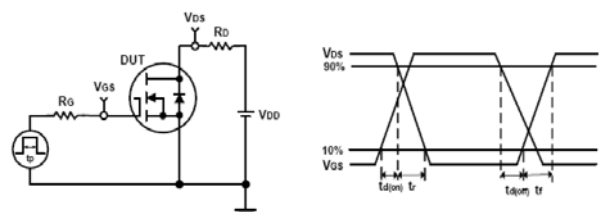
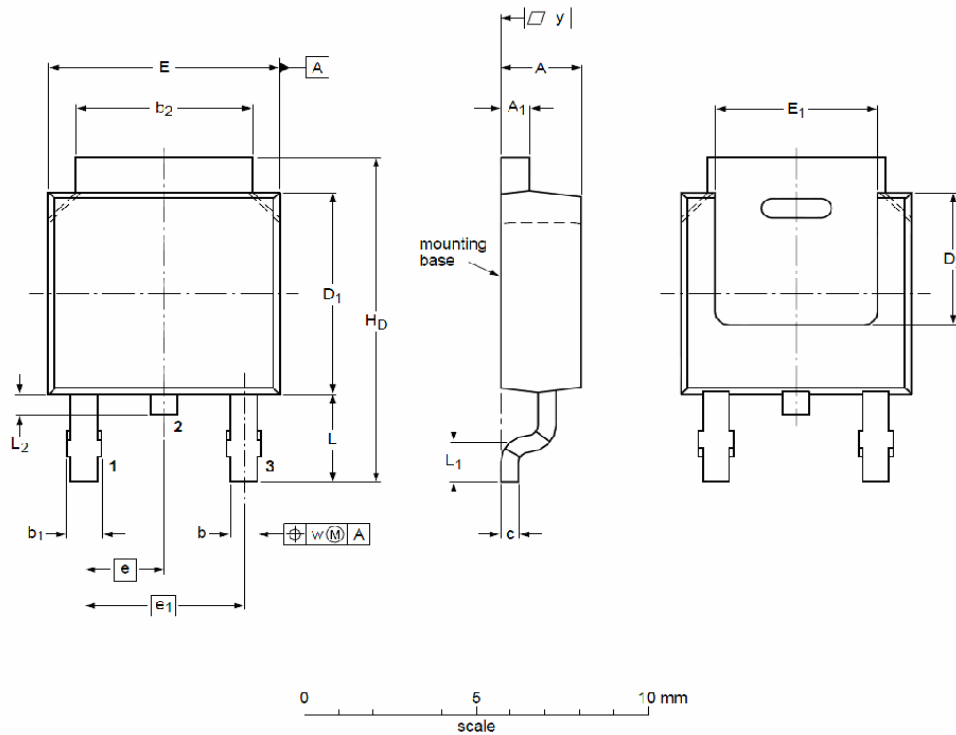


Fig11. Switching Time Test Circuit and waveforms

TO-252 Package Outline



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	2.22	2.30	2.38	A ₁	0.46	0.58	0.93
b	0.71	0.79	0.89	b ₁	0.90	0.98	1.10
b ₂	5.00	5.30	5.46	c	0.20	0.40	0.56
D ₁	5.98	6.05	6.22	D ₂	--	4.00	--
E	6.47	6.60	6.73	E ₁	5.10	5.28	5.45
e	--	2.28	--	e ₁	--	4.57	--
H _D	9.60	10.08	10.40	L	2.75	2.95	3.05
L ₁	--	0.50	--	L ₂	0.80	0.90	1.10
w	--	0.20	--	y	0.20	--	--

Customer Service

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